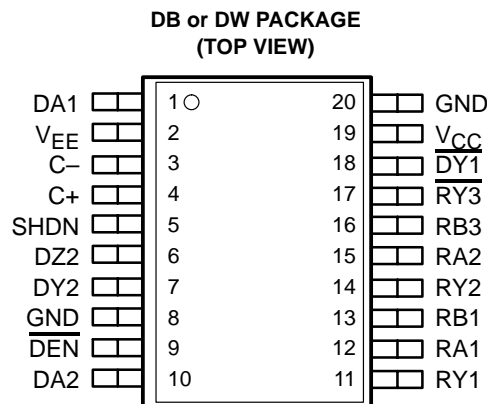


- Single-Chip Interface Solution for the 9-terminal GeoPort™ Host (DTE)
- Designed to Operate up to 4 Mbit/s Full Duplex
- Single 5-V Supply Operation
- 6-kV ESD Protection on All Terminals
- Backward compatible With AppleTalk™ and LocalTalk™
- Combines Multiple Components into a Single-chip Solution
- Complements the SN75LBC777 9-Terminal GeoPort Peripheral (DCE) Interface Device
- LinBiCMOS™ Process Technology



## description

The SN75LBC776 is a low-power LinBiCMOS device that incorporates the drivers and receivers for a 9-pin GeoPort host interface. GeoPort combines hybrid EIA/TIA-422-B and EIA/TIA-423-B drivers and receivers to transmit data up to four megabits per second (Mbit/s) full duplex. GeoPort is a serial communications standard that is intended to replace the RS-232, Appletalk, and LocalTalk printer ports all in one connector in addition to providing real-time data transfer capability. It provides point-to-point connections between GeoPort-compatible devices with data transmission rates up to 4 Mbit/s full duplex and a hot-plug feature. Applications include connection to telephony, integrated services digital network (ISDN), digital sound and imaging, fax-data modems, and other serial and parallel connections. The GeoPort is backwardly compatible to both LocalTalk and AppleTalk.

While the SN75LBC776 is powered-off ( $V_{CC} = 0$ ) the outputs are in a high-impedance state. When the shutdown (SHDN) terminal is high, the charge pump is powered down and the outputs are in a high-impedance state. The driver enable ( $\overline{DEN}$ ) terminal sends the outputs of the differential driver into a high-impedance state with a high input signal. All drivers and receivers have fail-safe mechanisms to ensure a high output state when the inputs are left open.

A switched-capacitor voltage converter generates the negative voltage required from a single 5-V supply using four 0.1- $\mu$ F capacitors, two capacitors between the C+ and C- terminals and two capacitors between  $V_{EE}$  and ground.

The SN75LBC776 is characterized for operation over the 0°C to 70°C temperature range.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

GeoPort, LocalTalk, and AppleTalk are trademarks of Apple Computer, Incorporated.  
LinBiCMOS is a trademark of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



[www.ti.com](http://www.ti.com)

Copyright © 2002, Texas Instruments Incorporated

# SN75LBC776 SINGLE-CHIP GeoPort™ TRANSCEIVER

SLLS221B – NOVEMBER 1995 – REVISED MARCH 2002

DRIVER FUNCTION TABLE†

INPUT DA1	INPUT DA2	ENABLE SHDN	ENABLE DEN	OUTPUT DY1	OUTPUT	
					DY2	DZ2
H	X	L	X	L	X	X
L	X	L	X	H	X	X
X	H	L	L	X	H	L
X	L	L	L	X	L	H
OPEN	OPEN	L	L	L	H	L
X	X	H	X	Z	Z	Z
X	X	X	H	X	Z	Z
X	X	OPEN	OPEN	Z	Z	Z

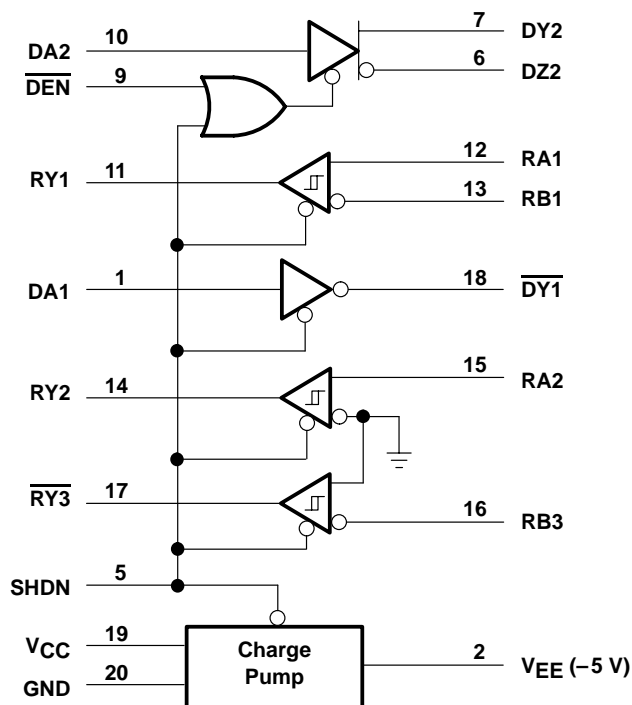
† H = high level L = low level X = irrelevant ? = indeterminate Z = high impedance (off)

RECEIVER FUNCTION TABLE†

INPUT RA1 RB1		INPUT RA2 & RB3	ENABLE SHDN	OUTPUT RY1	OUTPUT RY2	OUTPUT RY3
H	L	H	L	H	H	L
L	H	L	L	L	L	H
OPEN	OPEN	OPEN	L	H	H	H
SHORT‡	SHORT‡	SHORT‡	L	?	?	?
X	X	X	H	Z	Z	Z
X	X	X	OPEN	Z	Z	Z

† H = high level L = low level X = irrelevant ? = indeterminate Z = high impedance (off)  
‡  $-0.2\text{ V} < V_{ID} < 0.2\text{ V}$

## function logic diagram (positive logic)



**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Positive supply voltage range, $V_{CC}$ (see Note 1)	–0.5 to 7 V
Negative supply voltage range, $V_{EE}$ (see Note 1)	–7 to 0.5 V
Receiver input voltage range (RA, RB)	–15 V to 15 V
Receiver differential input voltage range, $V_{ID}$	–12 to 12 V
Receiver output voltage range (RY)	–0.5 V to 5.5 V
Driver output voltage range (Power Off) ( $\overline{DY1}$ , DY2, DZ2)	–15 V to 15 V
Driver output voltage range (Power On) ( $\overline{DY1}$ , DY2, DZ2)	–11 V to 11 V
Driver input voltage range (DA, SHND, $\overline{DEN}$ )	–0.5 V to $V_{CC} + 0.4$ V
Continuous total power dissipation	See Dissipation Rating Table
Electrostatic discharge (see Note 2): (Bus terminals), Class 3, A	6 kV
(Bus terminals), Class 3, B	500 V
(All terminals), Class 3, A	6 kV
(All terminals), Class 3, B	500 V
Operating free-air temperature range, $T_A$	0°C to 70°C
Storage temperature range, $T_{stg}$	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to network ground terminal unless otherwise noted.  
2. This parameter is measured in accordance with MIL-STD-883C, Method 3015.7.

**DISSIPATION RATING TABLE**

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	OPERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING
DB	1035 mW	8.3 mW/°C	660 mW
DW	1125 mW	9.0 mW/°C	720 mW

# SN75LBC776 SINGLE-CHIP GeoPort™ TRANSCEIVER

SLLS221B – NOVEMBER 1995 – REVISED MARCH 2002

## recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, $V_{CC}$		4.75	5	5.25	V
High-level input voltage, $V_{IH}$	DA, SHDN, $\overline{DEN}$	2		5.25	V
Low-level input voltage, $V_{IL}$	DA, SHDN, $\overline{DEN}$			0.8	V
Receiver common-mode input voltage, $V_{IC}$		-7		7	V
Receiver differential input voltage, $V_{ID}$		-12		12	V
Voltage-converter filter capacitance		0.2			$\mu$ F
Voltage-converter filter-capacitor equivalent series resistance (ESR)				0.2	$\Omega$
Operating free-air temperature, $T_A$		0		70	$^{\circ}$ C

## driver electrical characteristics over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
$V_{OH}$	High-level output voltage	Single ended, See Figure 1	$R_L = 12\text{ k}\Omega$	3.6	4.53		V
			$R_L = 120\ \Omega$	2	3.63		V
$V_{OL}$	Low-level output voltage		$R_L = 12\text{ k}\Omega$		-4.53	-3.6	V
			$R_L = 120\ \Omega$		-2.7	-1.8	V
$ V_{OD} $	Magnitude of differential output voltage $ V(DY) - V(DZ) $	$R_L = 120\ \Omega$ , See Figure 2		4			V
$\Delta V_{OD} $	Change in differential voltage magnitude					250	mV
$V_{OC}$	Common-mode output voltage	See Figure 3		-1		3	V
$ \Delta V_{OC(SS)} $	Magnitude of change, common-mode steady state output voltage					200	mV
$ \Delta V_{OC(PP)} $	Magnitude of change, common-mode peak-to-peak output voltage				700		mV
$I_{CC}$	Supply current	SHDN = $\overline{DEN} = 0\text{ V}$ , No load			7	15	mA
		SHDN = $\overline{DEN} = 5\text{ V}$ , No load				100	$\mu$ A
$I_{OZ}$	High-impedance output current	$V_O = -10\text{ V to }10\text{ V}$ , $V_{CC} = 0\text{ or }5\text{ V}$				$\pm 100$	$\mu$ A
$I_{OS}$	Short-circuit output current (see Note 3)	$V_O = -5\text{ V to }5\text{ V}$			$\pm 170$	$\pm 450$	mA

NOTE 3: Not more than one output should be shorted at one time.

**driver switching characteristics over operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT	
t <sub>PHL</sub>	Propagation delay time, high-to-low level output	Single ended, See Figure 4		42	75	ns	
t <sub>PLH</sub>	Propagation delay time, low-to-high level output			41	75	ns	
t <sub>PZL</sub>	Driver output enable time to low-level output		SHDN		25	100	μs
t <sub>PZH</sub>	Driver output enable time to high-level output				25	100	μs
t <sub>PLZ</sub>	Driver output disable time from low-level output				28	100	ns
t <sub>PHZ</sub>	Driver output disable time from high-level output				37	100	ns
t <sub>r</sub>	Rise time			10	25	75	ns
t <sub>f</sub>	Fall time			10	23	75	ns
t <sub>PHL</sub>	Propagation delay time, high-to-low level output		Differential, See Figure 5		40	75	ns
t <sub>PLH</sub>	Propagation delay time, low-to-high level output				42	75	ns
t <sub>PZL</sub>	Driver output enable time to low-level output	SHDN			25	100	μs
		$\overline{\text{DEN}}$			29	150	ns
t <sub>PZH</sub>	Driver output enable time to high-level output	SHDN			25	100	μs
		$\overline{\text{DEN}}$			35	150	ns
t <sub>PLZ</sub>	Driver output disable time from low-level output	SHDN			28	100	ns
		$\overline{\text{DEN}}$			34	100	ns
t <sub>PHZ</sub>	Driver output disable time from high-level output	SHDN			37	100	ns
		$\overline{\text{DEN}}$			34	100	ns
t <sub>r</sub>	Rise time			10	27	75	ns
t <sub>f</sub>	Fall time			10	26	75	ns
t <sub>SK(p)</sub>	Pulse skew,  t <sub>PLH</sub> – t <sub>PHL</sub>					22	ns

**receiver electrical characteristics over operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V <sub>IT+</sub>	Positive-going input threshold voltage	See Figure 6			200	mV
V <sub>IT-</sub>	Negative-going input threshold voltage			-200		
V <sub>hys</sub>	Differential input voltage hysteresis (V <sub>IT+</sub> – V <sub>IT-</sub> )				50	mV
V <sub>OH</sub>	High-level output voltage (see Note 4)	V <sub>IC</sub> = 0, I <sub>OH</sub> = -2 mA, See Figure 6	2	4.9		V
V <sub>OL</sub>	Low-level output voltage	V <sub>IC</sub> = 0, I <sub>OL</sub> = 2 mA, See Figure 6		0.2	0.8	V
I <sub>OS</sub>	Short-circuit output current	V <sub>O</sub> = 0	-85	-45		mA
		V <sub>O</sub> = V <sub>CC</sub>		47	+85	
R <sub>I</sub>	Input resistance	V <sub>CC</sub> = 0 or 5.25 V, V <sub>I</sub> = -12 V to 12 V	6	30		kΩ

NOTE 4: When the inputs are left unconnected, receivers one and two interpret these as high-level inputs and receiver three interprets these as low-level inputs so that all outputs are at a high level.

# SN75LBC776 SINGLE-CHIP GeoPort™ TRANSCEIVER

SLLS221B – NOVEMBER 1995 – REVISED MARCH 2002

receiver switching characteristics over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t <sub>PHL</sub>	Propagation delay time, high-to-low-level output	R <sub>L</sub> = 2 kΩ, See Figure 6	C <sub>L</sub> = 15 pF,	31	75	ns
t <sub>PLH</sub>	Propagation delay time, low-to-high level output			30	75	ns
t <sub>r</sub>	Rise time			15	30	ns
t <sub>f</sub>	Fall time			15	30	ns
t <sub>SK(P)</sub>	Pulse skew  t <sub>PLH</sub> - t <sub>PHL</sub>				20	ns
t <sub>PZL</sub>	Receiver output enable time to low level output	Differential, See Figure 7	C <sub>L</sub> = 50 pF,	35	100	ns
t <sub>PZH</sub>	Receiver output enable time to high level output			32	100	ns
t <sub>PLZ</sub>	Receiver output disable time from low level output			21	100	ns
t <sub>PHZ</sub>	Receiver output disable time from high level output			21	100	ns
t <sub>PZL</sub>	Receiver output enable time to low level output	Single ended, See Figure 7	C <sub>L</sub> = 50 pF,	12	25	μs
t <sub>PZH</sub>	Receiver output enable time to high level output			12	25	μs
t <sub>PLZ</sub>	Receiver output disable time from low level output			25	100	ns
t <sub>PHZ</sub>	Receiver output disable time from high level output			125	400	ns

PARAMETER MEASUREMENT INFORMATION

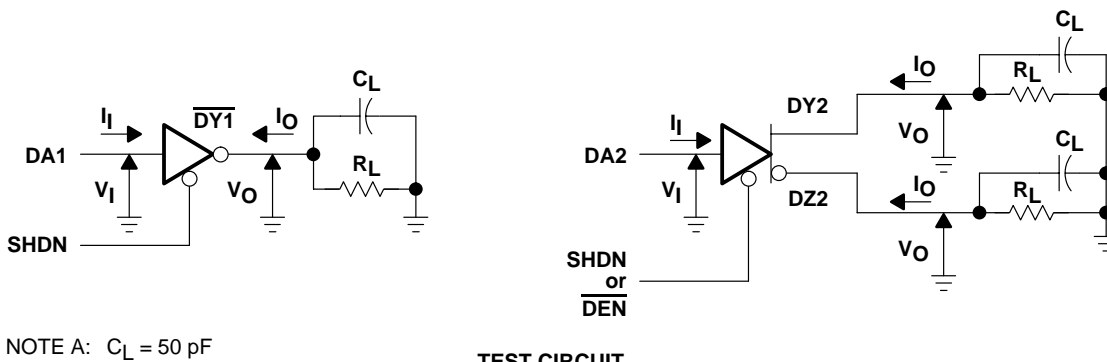


Figure 1. Single-Ended Driver DC Parameter Test

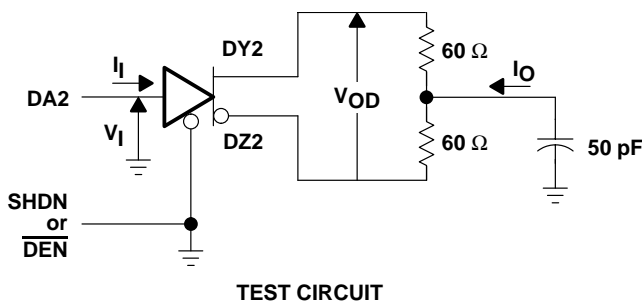
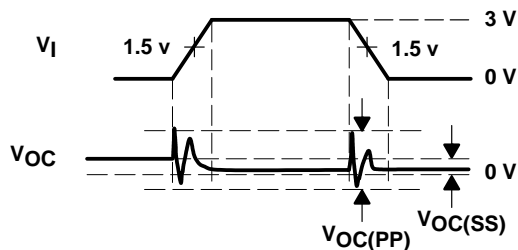
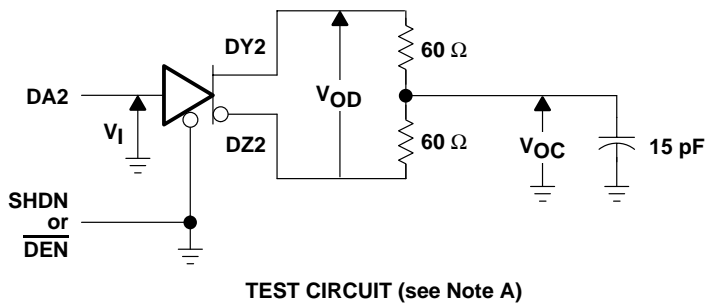


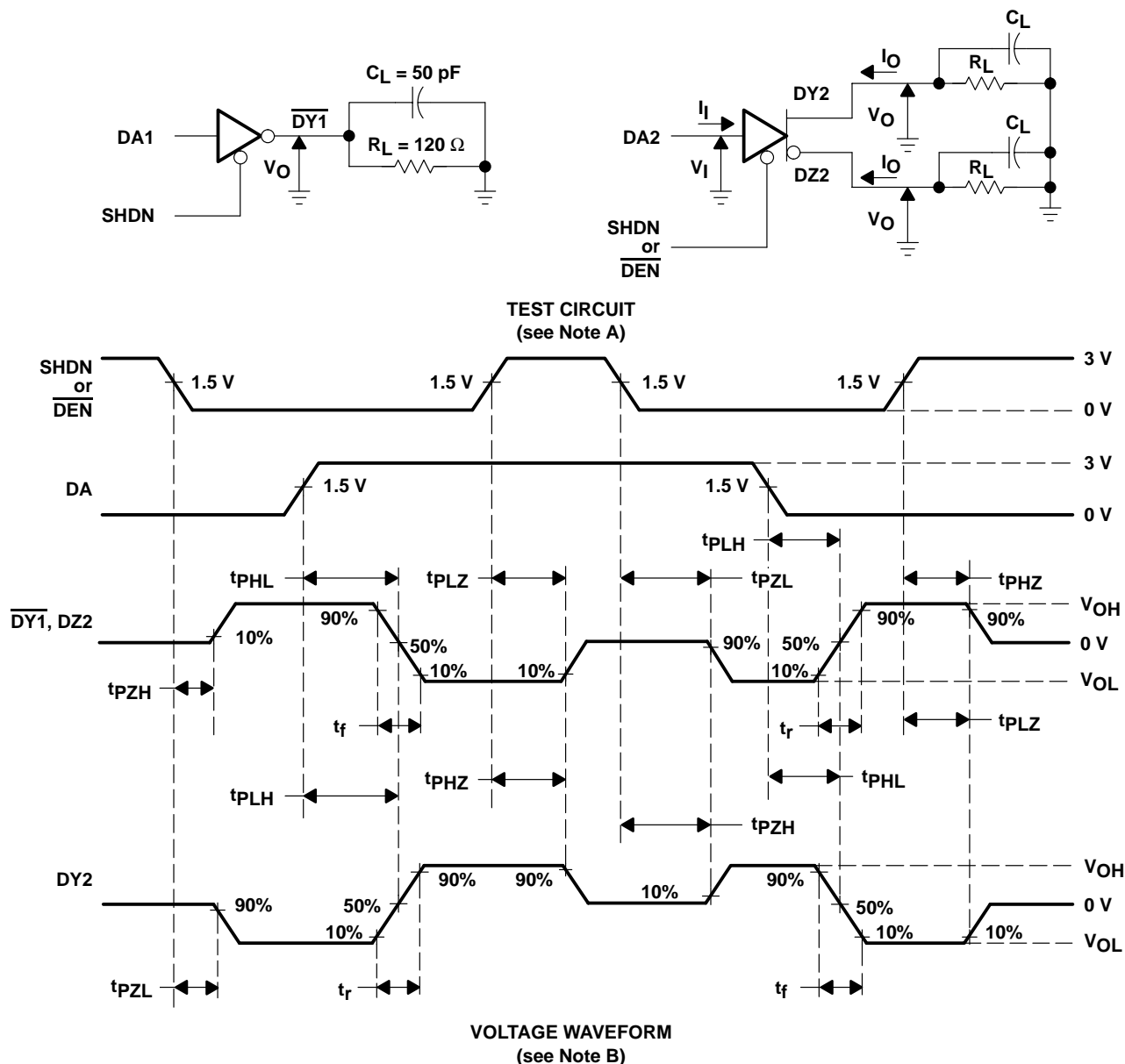
Figure 2. Differential Driver DC Parameter Test



NOTE A: Measured 3dB bandwidth = 300 MHz

Figure 3. Differential-Driver Common-Mode Output Voltage Tests

**PARAMETER MEASUREMENT INFORMATION**



NOTES: A.  $C_L = 50 \text{ pF}$ ,  $R_L = 120 \Omega$   
 B. The input waveform  $t_r$ ,  $t_f \leq 10 \text{ ns}$ .

**Figure 4. Single-Ended Driver Propagation and Transition Times**



PARAMETER MEASUREMENT INFORMATION

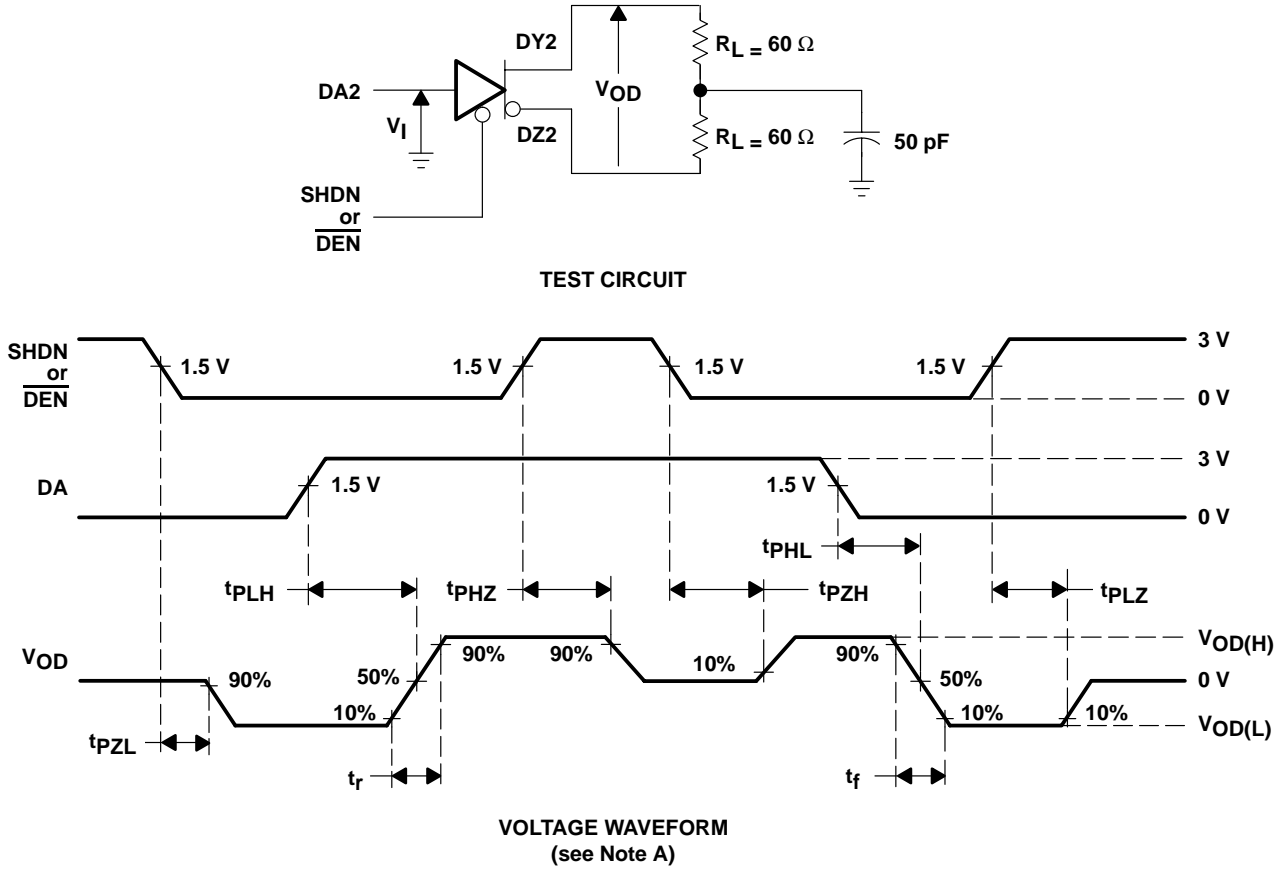


Figure 5. Differential Driver Propagation and Transition Times

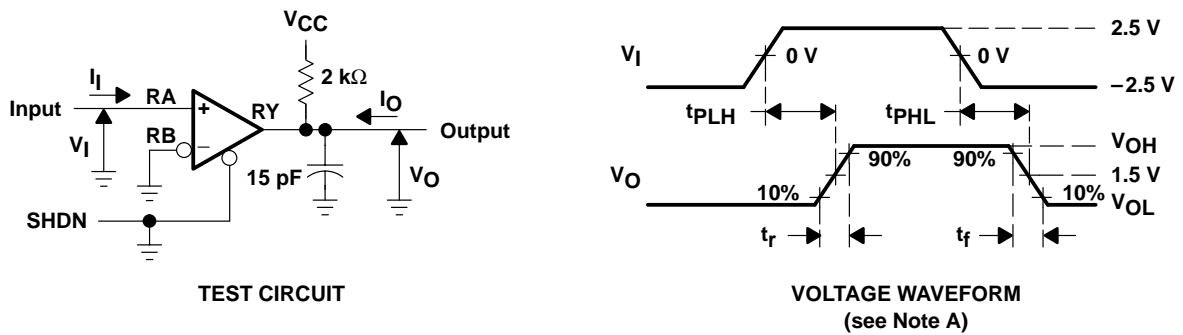


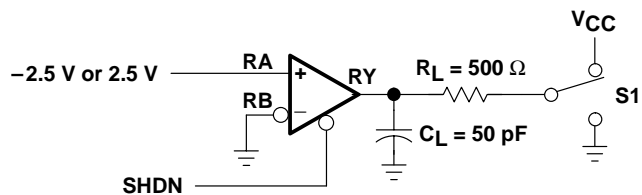
Figure 6. Receiver Propagation and Transition Times

NOTE A: The input waveform  $t_r$ ,  $t_f \leq 10$  ns.

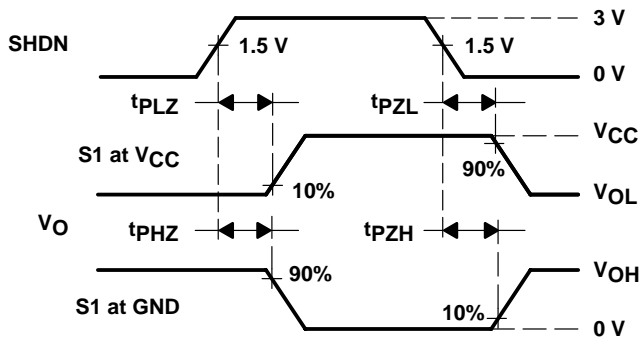
# SN75LBC776 SINGLE-CHIP GeoPort™ TRANSCEIVER

SLLS221B – NOVEMBER 1995 – REVISED MARCH 2002

## PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT

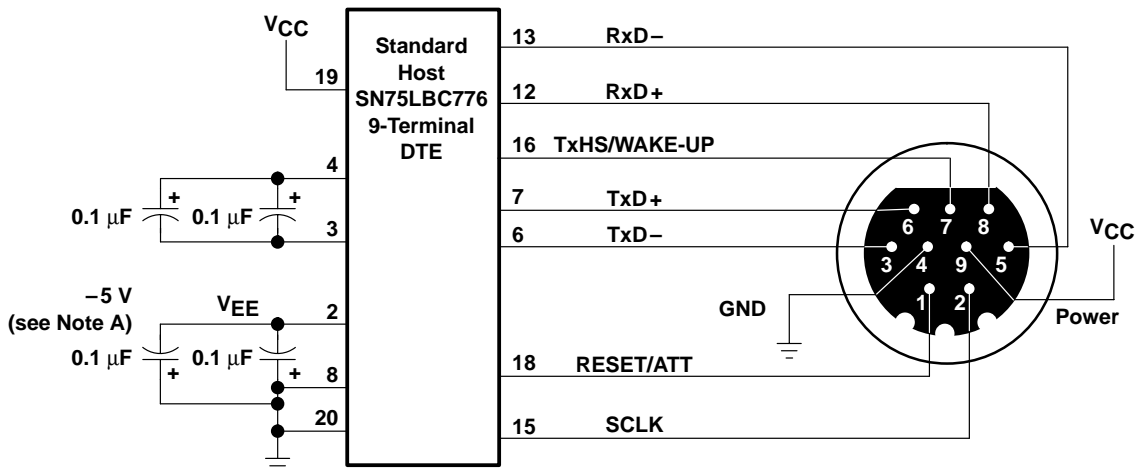
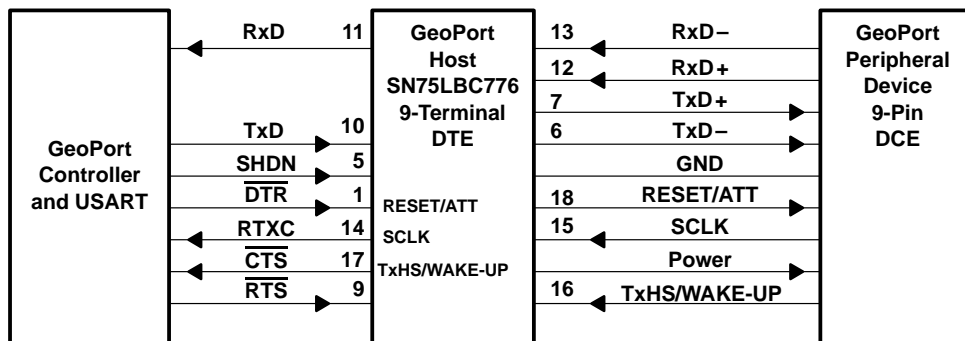


VOLTAGE WAVEFORM  
(see Note A)

NOTE A: The input waveform  $t_r, t_f \leq 10$  ns.

Figure 7. Receiver Enable and Disable Test Circuit and Waveforms

APPLICATION INFORMATION



NOTE A: The AVX 0603YC104MATXA or equivalent is one of the possible capacitors that can be used as the charge pump capacitor.

Figure 8. GeoPort 9-Terminal DTE Connection Application

# SN75LBC776 SINGLE-CHIP GeoPort™ TRANSCEIVER

SLLS221B – NOVEMBER 1995 – REVISED MARCH 2002

## APPLICATION INFORMATION

### generator characteristics

PARAMETER	TEST CONDITIONS	EIA/TIA-232/V.28		EIA/TIA-423/V.10		562		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
V <sub>O</sub>	Output voltage magnitude	Open circuit		25	4	6	13.2	V
		3 kΩ ≤ R <sub>L</sub> ≤ 7 kΩ		5	15	NA	3.7	V
		R <sub>L</sub> = 450 Ω		NA	3.6	NA	NA	V
V <sub>O</sub> (RING)	Output voltage ringing	NA		10%		5%		
I <sub>OS</sub>	Short-circuit output current	V <sub>O</sub> = 0		100		150		60 mA
I <sub>O</sub> (OFF)	Power-off output current	V <sub>CC</sub> = 0,  V <sub>O</sub>   < 2 V		300		NA		300 Ω
		V <sub>CC</sub> = 0,  V <sub>O</sub>   < 6 V		NA		±100		NA μA
SR	Output voltage slew rate			30		NA		4 30 V/μs
t <sub>t</sub>	Transition time	±3.3 V to ±3.3 V		NA		NA		0.22 2.1 μs
		±3 V to ±3 V		0.04		NA		NA ui†
		10% to 90%		NA		0.3		NA ui†

† ui is the unit interval and is the inverse of the signaling rate (bit transmit time).

### receiver characteristics

PARAMETER	TEST CONDITIONS	EIA/TIA-232/V.28		EIA/TIA-423/V.10		562		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
V <sub>I</sub>	Input voltage magnitude	25		10		25		V
V <sub>IT</sub>	Input voltage threshold	V <sub>I</sub>   < 15 V		-3 3		-3 3		V
		V <sub>I</sub>   < 10 V		NA		-0.2 0.2		NA
R <sub>I</sub>	Input resistance	3 V <  V <sub>I</sub>   < 15 V		3 7		NA		3 7 kΩ
		V <sub>I</sub>   < 10 V		NA		4		NA kΩ

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN75LBC776DBR	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	75LB776	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

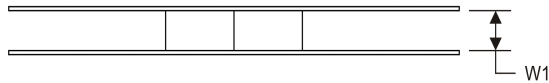
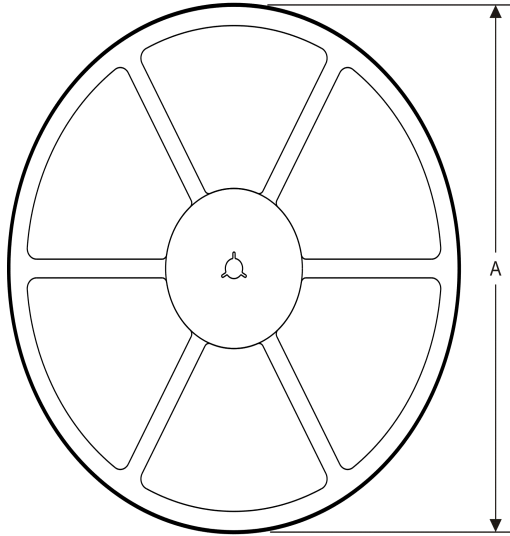
(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

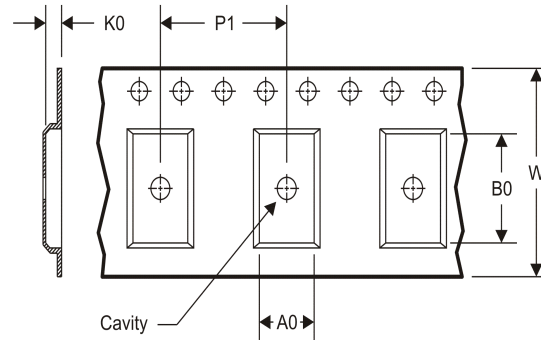
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**TAPE AND REEL INFORMATION**

**REEL DIMENSIONS**



**TAPE DIMENSIONS**



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

**TAPE AND REEL INFORMATION**

\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75LBC776DBR	SSOP	DB	20	2000	330.0	16.4	8.2	7.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75LBC776DBR	SSOP	DB	20	2000	367.0	367.0	38.0

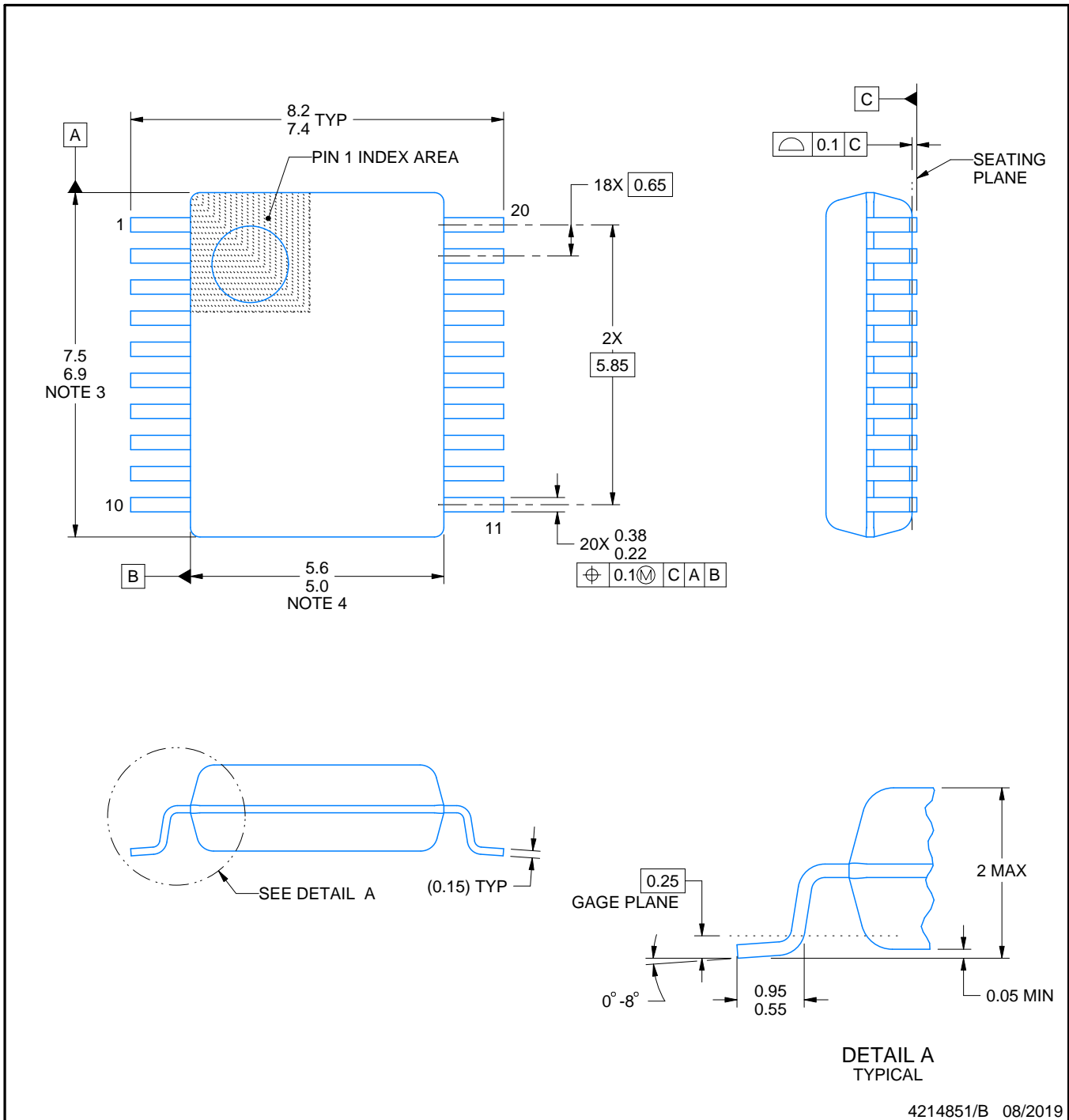
# DB0020A



# PACKAGE OUTLINE

## SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



4214851/B 08/2019



# EXAMPLE BOARD LAYOUT

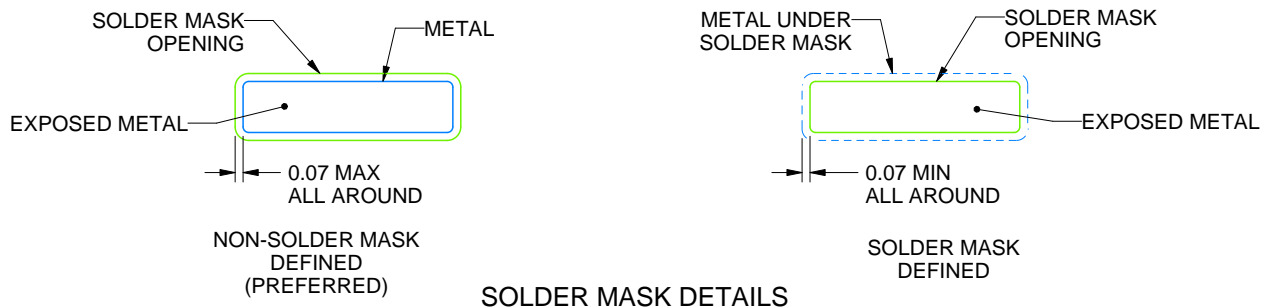
DB0020A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4214851/B 08/2019

NOTES: (continued)

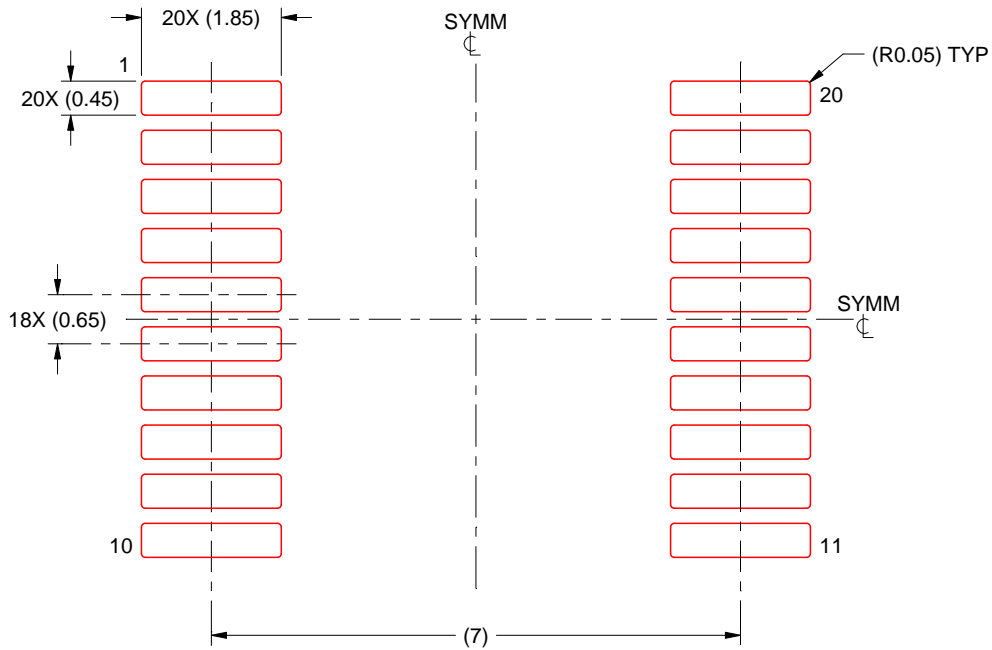
- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DB0020A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4214851/B 08/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale ([www.ti.com/legal/termsofsale.html](http://www.ti.com/legal/termsofsale.html)) or other applicable terms available either on [ti.com](http://ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2020, Texas Instruments Incorporated